

SPICE Device Model SiR402DP Vishay Siliconix

N-Channel 30-V (D-S) MOSFET

CHARACTERISTICS

- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS

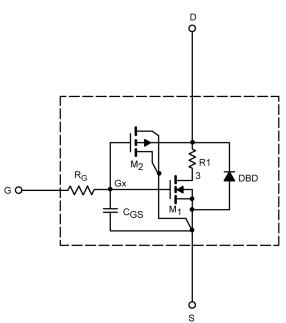
- Apply for both Linear and Switching Application
- Accurate over the 55 °C to 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the N-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 $^{\circ}$ C to 125 $^{\circ}$ C temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

SUBCIRCUIT MODEL SCHEMATIC

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.



This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.



SPECIFICATIONS (T _j = 25 °C UNLESS OTHERWISE NOTED)					
Parameter	Symbol	Test Condition	Simulated Data	Measured Data	Unit
Static			•		
Gate Threshold Voltage	$V_{_{\rm GS(th)}}$	$V_{_{DS}} = V_{_{GS}}$, $I_{_{D}} = 250 \ \mu A$	1.7		V
Drain-Source On-State Resistance [®]	$R_{DS(on)}$	$V_{_{\mathrm{GS}}}$ = 10 V, $I_{_{\mathrm{D}}}$ = 20 A	0.0045	0.0048	Ω
		$V_{_{\rm GS}} = 4.5 \text{ V}, \text{ I}_{_{\rm D}} = 17.5 \text{ A}$	0.0063	0.0064	
Forward Transconductance ^a	g_{fs}	$V_{_{DS}} = 15 \text{ V}, \text{ I}_{_{D}} = 20 \text{ A}$	60	82	S
Diode Forward Voltage ^a	V _{SD}	I _s = 10 A	0.79	0.80	V
Dynamic ^b			-		
Input Capacitance	C _{iss}	$V_{_{DS}} = 15 \text{ V}, \text{ V}_{_{GS}} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	1640	1700	pF
Output Capacitance	C _{oss}		373	350	
Reverse Transfer Capacitance	C _{rss}		121	140	
Total Gate Charge	Q _g	$V_{_{\mathrm{DS}}}$ = 15 V, $V_{_{\mathrm{GS}}}$ = 10 V, $I_{_{\mathrm{D}}}$ = 20 A	25	28	nC
		$V_{_{DS}} = 15 \text{ V}, V_{_{GS}} = 4.5 \text{ V}, I_{_{D}} = 20 \text{ A}$	13	14	
Gate-Source Charge	Q _{gs}		5.4	5.4	
Gate-Drain Charge	Q_{gd}		4.6	4.6	

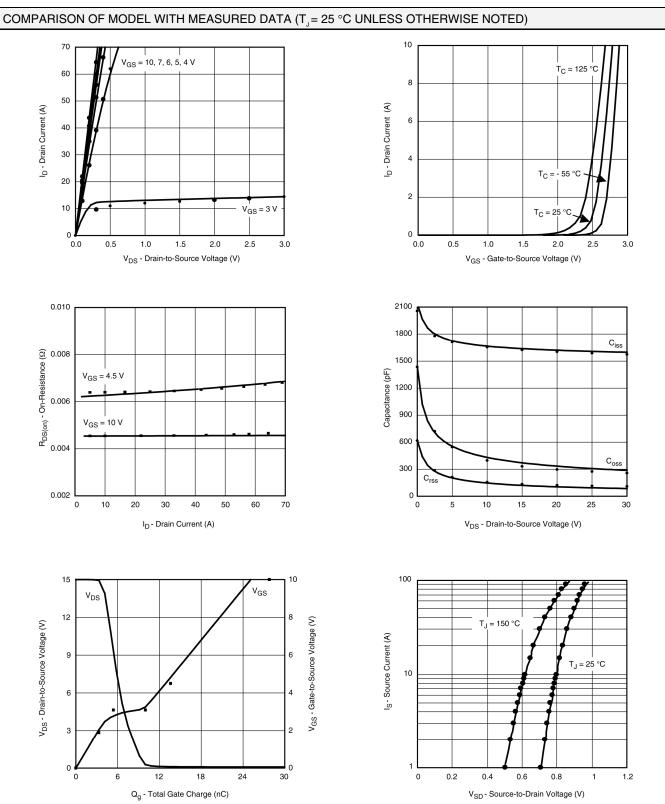
Notes

a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.



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Note: Dots and squares represent measured data.



Vishay

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